

2SK2935

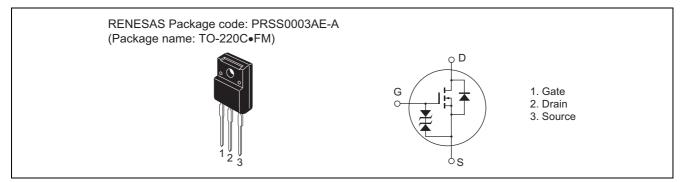
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1049-0400 (Previous: ADE-208-588B) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS} = 0.020 \Omega$ typ.
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	35	А
Drain peak current	Note1	140	А
Body-drain diode reverse drain current	I _{DR}	35	А
Avalanche current	I _{AP} Note3	35	А
Avalanche energy	E _{AR} ^{Note3}	105	mJ
Channel dissipation	Pch Note2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. Value at Tc = 25°C

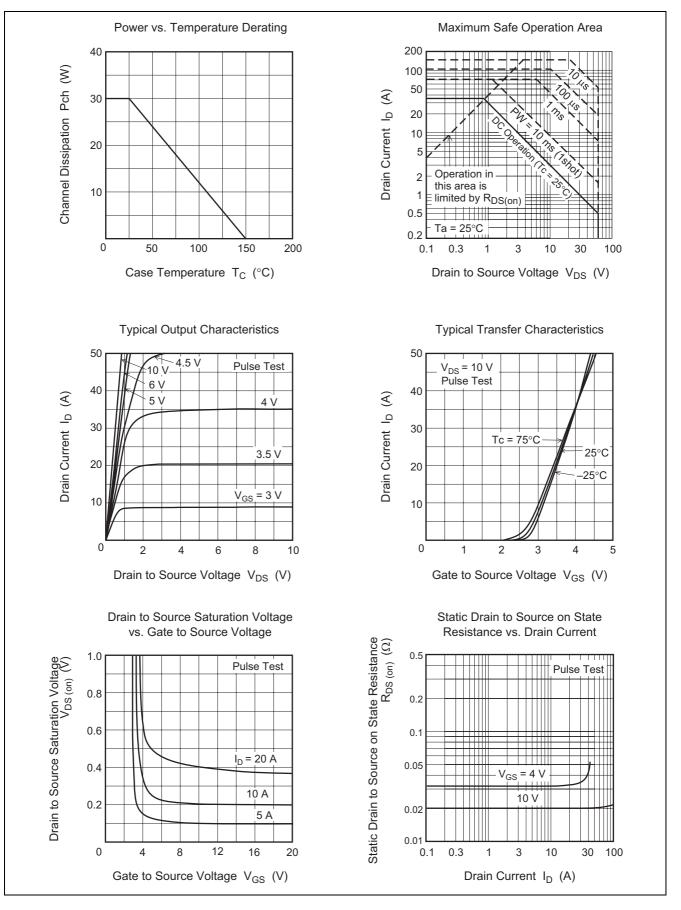
3. Value at Tch = 25°C, Rg \ge 50 Ω

Electrical Characteristics

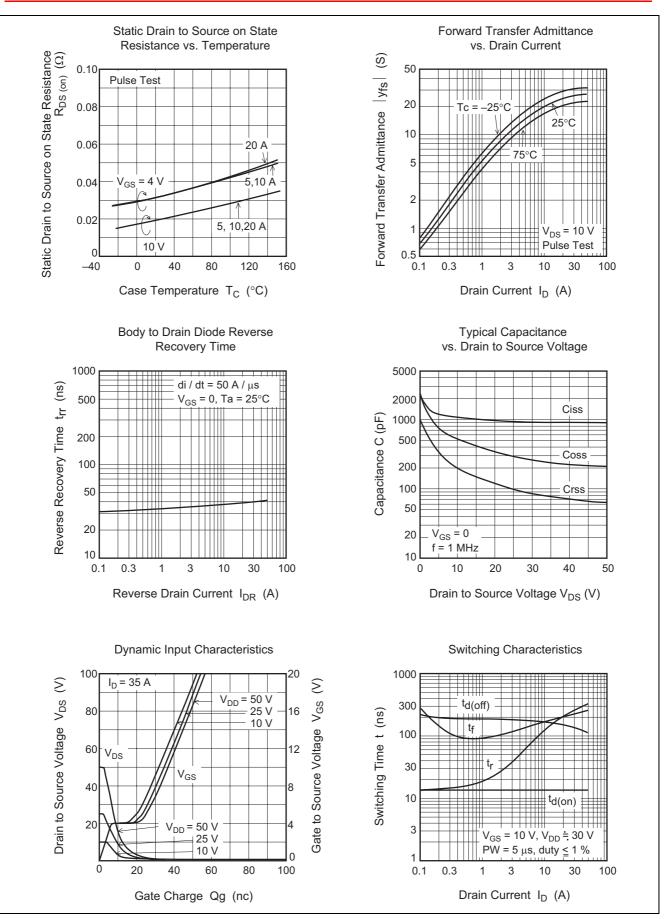
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	60	_		V	I _D = 10 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_	_	V	$I_{\rm G} = \pm 100 \ \mu A, \ V_{\rm DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μA	$V_{DS} = 60 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.5	_	2.5	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state	R _{DS(on)}		0.020	0.026	Ω	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}		0.032	0.050	Ω	$I_D = 15 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	14	23		S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss		1100	_	pF	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz
Output capacitance	Coss	_	540	_	pF	
Reverse transfer capacitance	Crss	_	200	_	pF	
Turn-on delay time	t _{d(on)}	_	15	_	ns	I _D = 15 A, V _{GS} = 10 V, R _L = 2 Ω
Rise time	tr	_	180	_	ns	
Turn-off delay time	t _{d(off)}	_	175	_	ns	
Fall time	t _f		195	—	ns	
Body-drain diode forward voltage	V _{DF}		0.95	—	V	I _F = 35 A, V _{GS} = 0
Body–drain diode reverse	t _{rr}		40	—	ns	I _F = 35 A, V _{GS} = 0
recovery time						di _F / dt = 50 A/ μs

Note: 4. Pulse test

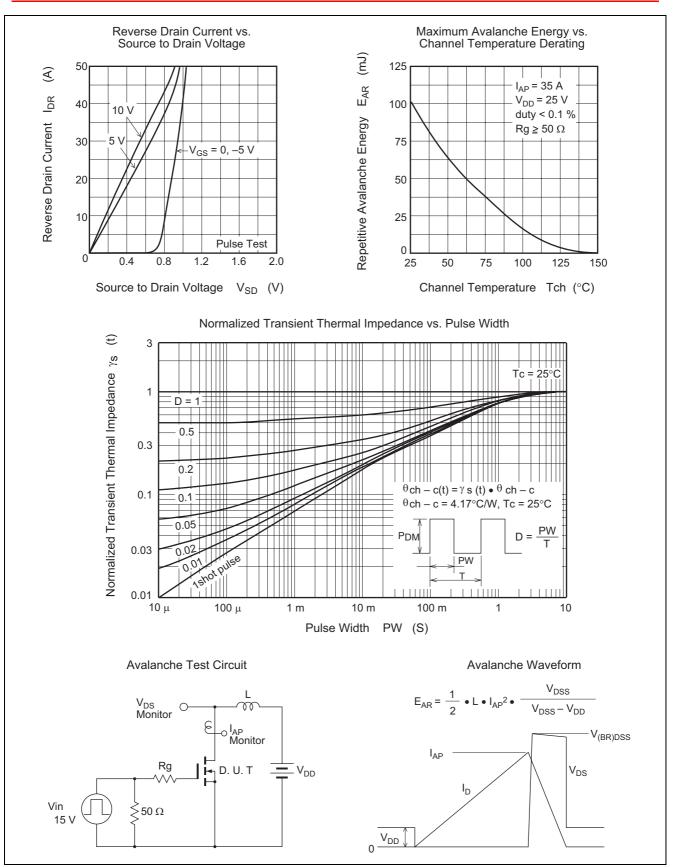
Main Characteristics



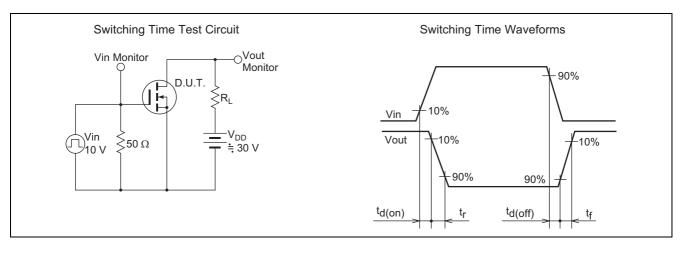






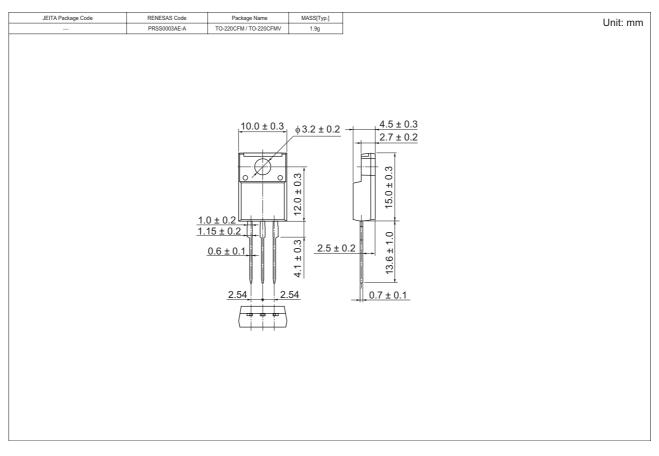








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2935-E	600 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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